

客户图

NOTES:

1. FINISH:

- 1.1 HOUSING: LCP BLACK,UL94V-0.
- 1.2 CONTACT: PHOSPHOR BRONZE ,GOLD (SEE P/N) PLATED IN CONTACT AREA, 80u" MIN MATTE TIN PLATED IN SOLDER AREA,50u" MIN. NICKEL UNDERPLATED OVERALL.

2. ELECTRICAL:

- 2.1 CURRENT RATING:3A;
- 2.2 DIELECTRIC WITHSTANDING VOLTAGE: 500V AC/MINUTE.
- 2.3 CONTACT RESISTANCE: 30mΩ MAX.
- 2.4 INSULATION RESISTANCE: 1000MΩ MIN.
- 2.5 OPERATION TEMPERATURE:-40°C TO +105°C.

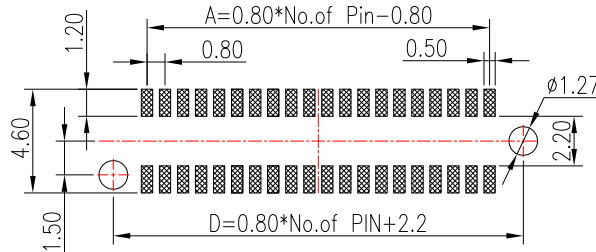
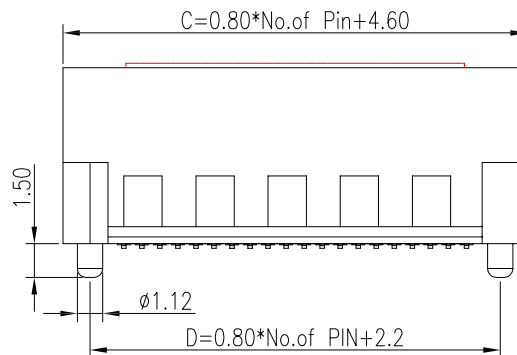
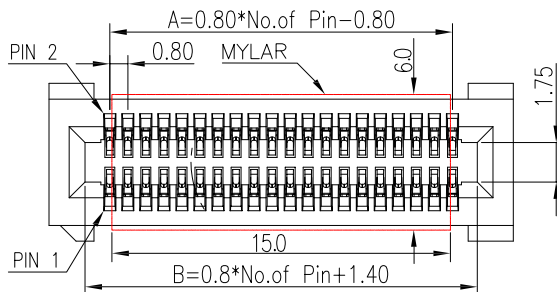
3.ORDER INFORMATION:

AA XXX XX 078 C 01

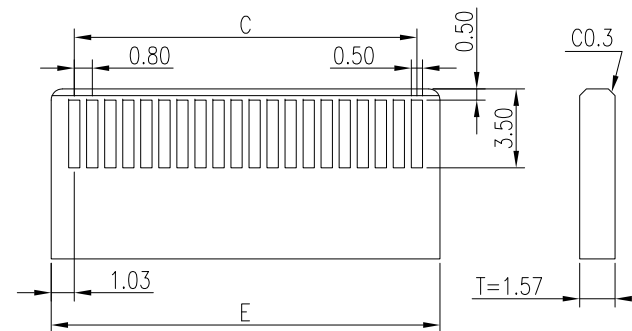
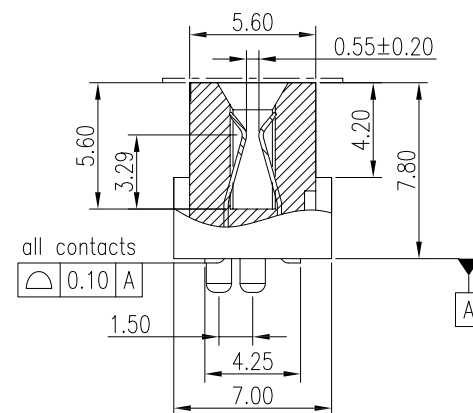
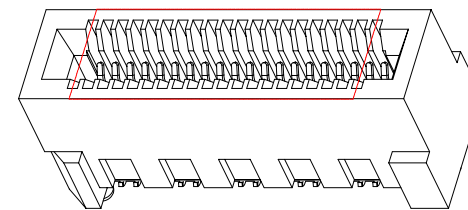
Pin数码	端子电镀:	塑胶高度:	包装方式:
010=2x5PIN	S1=1u" Gold/Tin	078=7.8mm	C=TRAY
.....	S2=3u" Gold/Tin		
200=2x100PIN	S3=5u" Gold/Tin		
	S4=10u" Gold/Tin		
	S5=15u" Gold/Tin		
	S6=30u" Gold/Tin		

TABLE1:

No. OF PIN	A	B	C	D	E
010:2x5PIN	3.20	5.40	8.60	6.20	5.25
020:2x10PIN	7.20	9.40	12.60	10.20	9.25
030:2x15PIN	11.20	13.40	16.60	14.20	13.25
040:2x20PIN	15.20	17.40	20.60	18.20	17.25
050:2x25PIN	19.20	21.40	24.60	22.20	21.25
060:2x30PIN	23.20	25.40	28.60	26.20	25.25
080:2x40PIN	31.20	33.40	36.60	34.20	33.25
100:2x50PIN	39.20	41.40	44.60	42.20	41.25
120:2x60PIN	47.20	49.40	52.60	50.20	49.25
150:2x75PIN	59.20	61.40	64.60	62.20	61.25
200:2x100PIN	79.20	81.40	84.60	82.20	81.25



RECOMMENDED PCB LAYOUT(TOP SIDE)
PCB BOARD TOLFRANCF±0.05



ROMMENED PLUG-PCB LAYOUT
TOLERANCE ±0.05

					OPERATION	DRAW	WLY	2021.03.01				
					X.X ±0.40	DESIGN	Jensen	2021.03.01				
					X.XX ±0.25	CHECK	Jack	2021.03.01				
					X.XXX ±0.15	APPROVE	Andy	2021.03.01				
A2	2022.08.05	CHANGE MYLAR			Angle ±3°				SIZE	A4	PART NO.	AAXXXXXX078C01
A1		NEW			DIM.	TOL	UNIT	mm	SHEET	1/1	TITLE:	0.80mm 金手指 180° SMT CONNECTOR L形焊脚
REV	DATE	MODIFICATION DESCRIPTION					SCALE	1:1	PROJ.		DRAW NO.	SP-227